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MF 8/2/2007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of: :
 Krishna G. Sachdev, et al. :
: :
Conf. No.: 3517 : Group Art Unit: 1712
: :
Appln. No.: 10/709,518 : Examiner: Michael J. Feely
: :
Filing Date: May 11, 2004 : Attorney Docket No.: FIS920030420US1

Title: THERMAL INTERFACE ADHESIVE AND REWORK

SECOND AMENDMENT AFTER FINAL REJECTION

The following amendment is submitted in response to the final Office Action dated May 21, 2007 in the above-identified U.S. patent application. A first amendment after final rejection filed on July 11, 2007 was not entered. This amendment is being filed within the three-month statutory period set for a response. Please amend the above-identified U.S. patent application, without prejudice, as follows. No fee is believed to be due in connection with filing of this paper. However, if any such fee is due, please charge such fee to deposit account No. 09-0458.

Amendments to and Listing of the Claims begin on page 2 of this paper.

Remarks begin on page 4 of this paper.